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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Donald C. Abbott

Art Unit: TBD

Serial No.: 10/073,523

Examiner: TBD

Filed: 02/11/02

Docket: TI-33822

For: Method for Fabricating Preplated Nickel/Palladium and Tin Leadframes

*Formal drawing
T. Steptoe
8-19*

LETTER TO THE OFFICIAL DRAFTSPERSON

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 3-27-02 as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

Karen Vertz
Karen Vertz

3-27-02
Date

Assistant Commissioner for
Patents
Washington, D. C. 20231

Dear Sir:

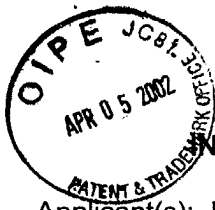
Enclosed are **TWO (2)** sheets of formal drawings for the above-referenced case. Please charge any necessary fees to Deposit Account No. 20-0668 of Texas Instruments Incorporated. This sheet is enclosed in triplicate.

Respectfully submitted,

Texas Instruments Incorporated
P.O. Box 655474 M/S 3999
Dallas, Texas 75265
(214) 939-8651

Gary C. Honeycutt
Gary C. Honeycutt
Reg. No. 20,250
Attorney for Applicant

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